



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

MATTHIAS BONKAβ AXEL PREUSSE MARKUS NOPPER

Serial No.: 10/629,106

Filed: July 29, 2003

Mail Stop RCE

P.O. Box 1450

Sir:

Commissioner for Patents

Alexandria, VA 22313-1450

For: METHOD OF PLATING A

SEMICONDUCTOR STRUCTURE

Examiner: Luan V. Van

Group Art Unit: 1753

Att'y Docket: 2000.108300/DE0340

Customer No.: 23720

PRELIMINARY AMENDMENT

CERTIFICATE OF MAILING
37 C.F.R 1.8

I hereby certify that this correspondence is being dep

I hereby certify that this correspondence is being deposited with the U.S.. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:

March 28, 2006

Date

Signature

Applicants hereby submit a Request for Continued Examination and Preliminary Amendment in response to the Final Office Action dated December 29, 2005, for which the three-month date for response is March 29, 2006.

A fee in the amount of \$790.00 is believed to be due. The Director is authorized to deduct such fee, and any other fees required under 37 C.F.R. §§ 1.16 to 1.21, from Advanced Micro Devices, Inc. Deposit Account No. 01-0365/DE0340.¹

Reconsideration of the application in view of the following amendments and remarks is respectfully requested.

¹ In the event the monies in that account are insufficient, the Director is authorized to withdraw funds from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.108300.